

#### Description

The TD816X1 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP4 package with different lead forming options.

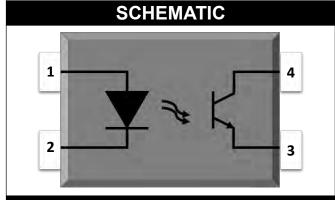
With the robust coplanar double mold structure, TD816X1 series provide the most stable isolation feature.

#### **Features**

- High isolation 5000 VRMS
- CTR flexibility available see order information
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- RoHS & REACH Compliance
- MSL class 1
- Halogen free (Optional)
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898
  - cUL- CSA Component Acceptance
     Service Notice No. 5A

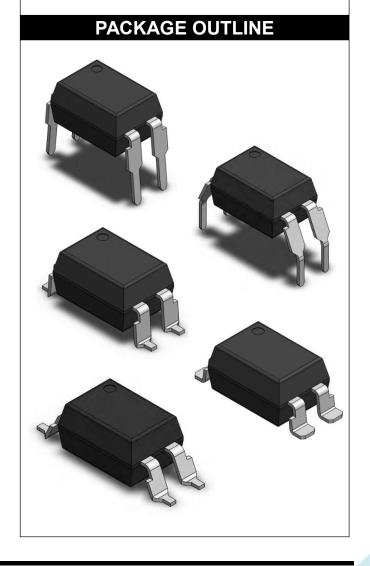
#### **Applications**

- Switch mode power supplies
- Programmable controllers
- Household appliances
- Office equipment



#### **PIN DEFINITION**

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector





ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	I <sub>F</sub>	60	mA				
Peak Forward Current	I <sub>FP</sub>	1	Α	1			
Reverse Voltage	V <sub>R</sub>	6	V				
Input Power Dissipation	Pı	100	mW				
OUTPUT							
Collector - Emitter Voltage	V <sub>CEO</sub>	80	V				
Emitter - Collector Voltage	V <sub>ECO</sub>	6	V				
Collector Current	Ic	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency

Note 2. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 



	ELECTRI	CAL OF	PTICA	L CHA	ARAC	TER	ISTICS at Ta=25°C	
PARAN	METER	SYMB OL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
				INF	UT			
Forward	Voltage	VF	-	1.24	1.4	V	IF=10mA	
Reverse	Reverse Current		-	-	10	μA	VR=6V	
Input Cap	Input Capacitance		-	10	-	pF	V=0, f=1kHz	
	OUTPUT							_
Collector Da	ark Current	I <sub>CEO</sub>	-	-	100	nA	VCE=20V, IF=0	
Collector Breakdow		BV <sub>CEO</sub>	80	-	-	V	IC=0.1mA, IF=0	
Emitter-0 Breakdow		BV <sub>ECO</sub>	6	-	-	V	IE=0.1mA, IF=0	
	1	TR	ANSFE	R CHA	RACT	ERIS	TICS	
	TD816	-	50	-	600			
	TD816A1	-	80	-	160			
Current	TD816B1	-	130	-	260			
Transfer	TD816C1	CTR	200	-	400	%	IF=5mA, VCE=5V	
Ratio	TD816D1	-	300	-	600			
	TD816E1		100	-	200			
	TD816F1		150	-	300			
Collector Saturation		V <sub>CE(sat)</sub>	-	0.06	0.2	V	IF=20mA, IC=1mA	
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C <sub>IO</sub>	-	0.4	1	pF	V=0, f=1MHz	
Response Time (Rise)		tr	-	6	18	μs	VCE=2V, IC=2mA	3
Response	Response Time (Fall)		-	8	18	μs	RL=100Ω	3
Cut-off Frequency		fc	-	80	-	kHz	VCE=2V, IC=2mA RL=100Ω,-3dB	4

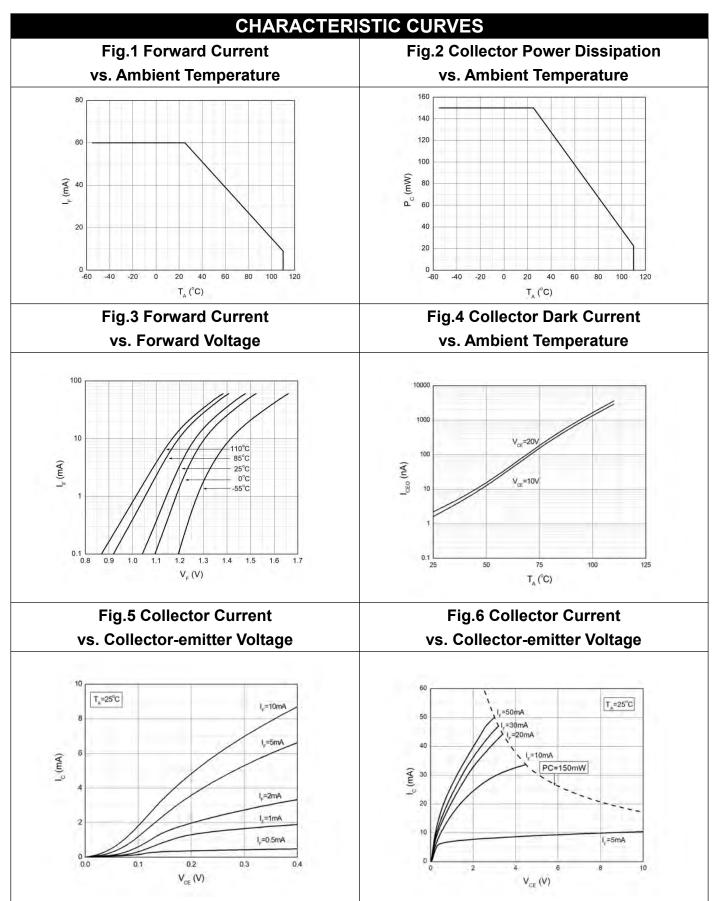
Note 3. Fig.12&13

Note 4. Fig.14



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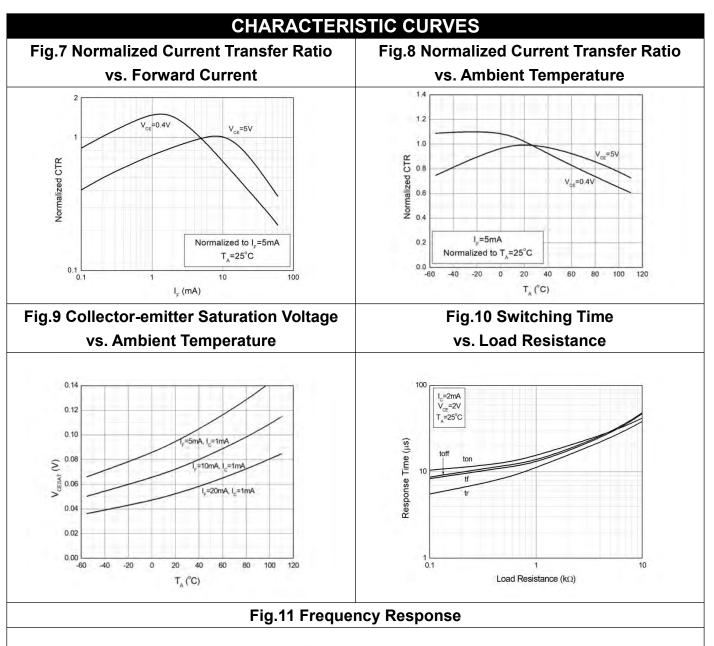
## DIP4, DC Input, Photo Transistor Coupler

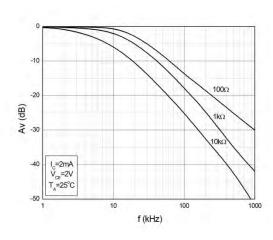


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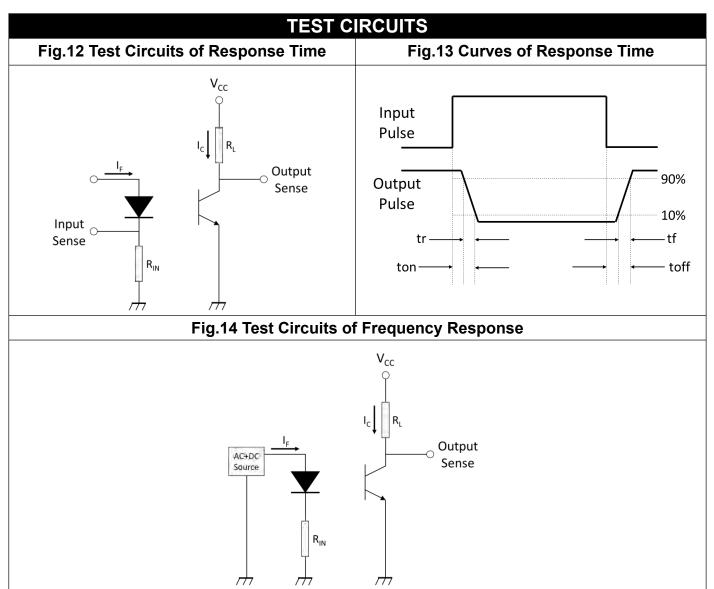
Release Date: 2024/08/12











4.58±0.30

Typ.2.20

Typ.2.54



## DIP4, DC Input, Photo Transistor Coupler

# PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Standard DIP - Through Hole (DIP Type) 6.50±0.20 4.58±0.20 7.62±0.30 1.30±0.10 3.50±0.20 4.50±0.30 Тур.2.80 Typ.0.50 Typ.0.25 5°~15° Typ.2.54 7.62~9.50 Gullwing (400mil) Lead Forming – Through Hole (M Type) 6.50±0.20 4.58±0.20 7.62±0.30 1.30±0.10

3.50±0.20

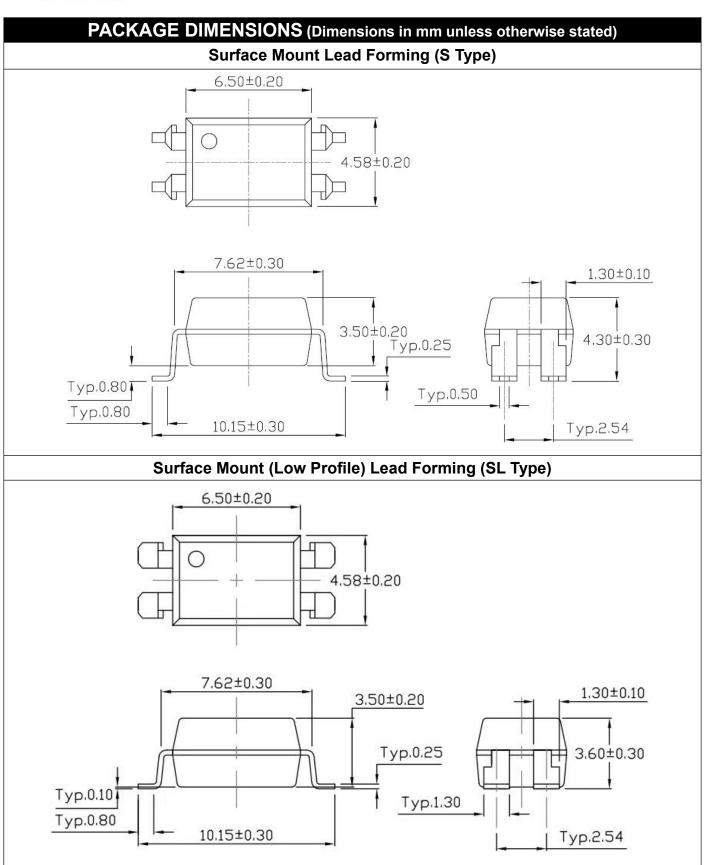
Typ.0.50

Document No: DWI-10140 Rev: A00 Release Date: 2024/08/12

Typ.0.25

10.16±0.30

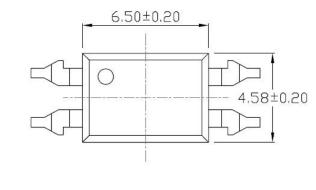


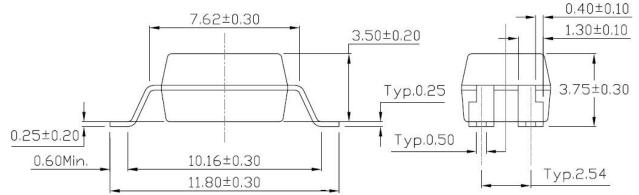




#### PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

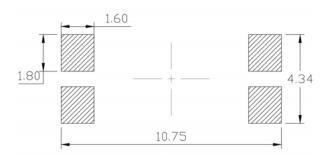
**Surface Mount (Gullwing) Lead Forming (SLM Type)** 



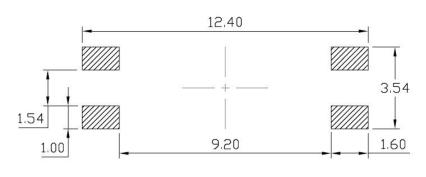


#### RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

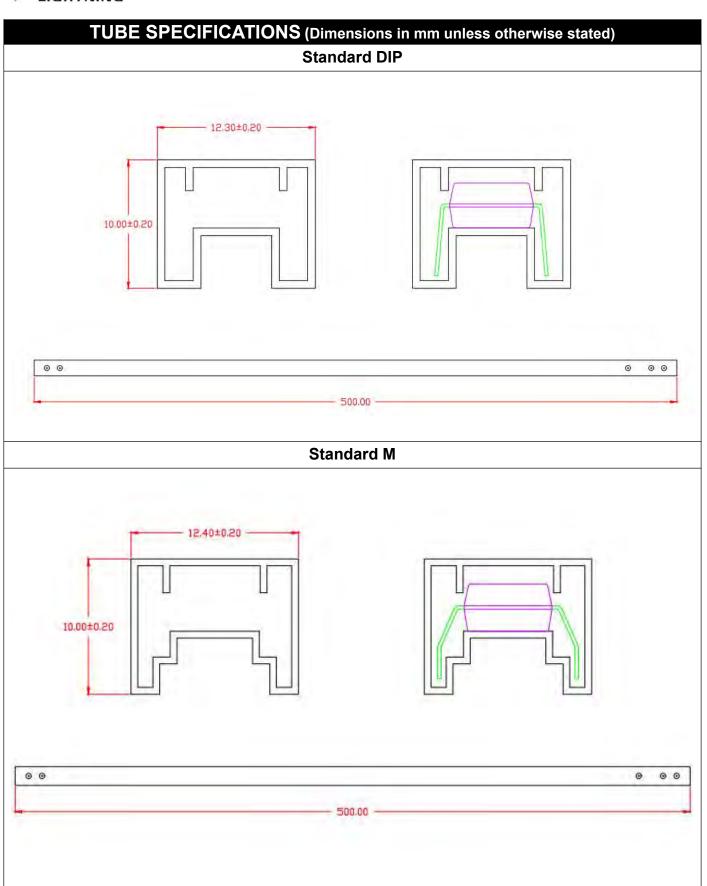
Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming



#### **Surface Mount (Gullwing) Lead Forming**

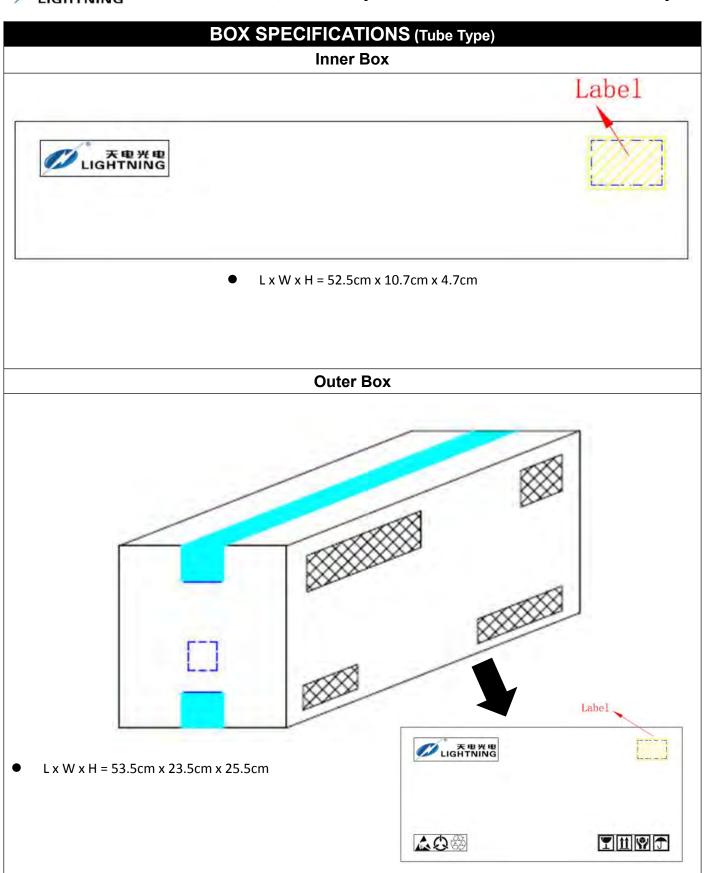




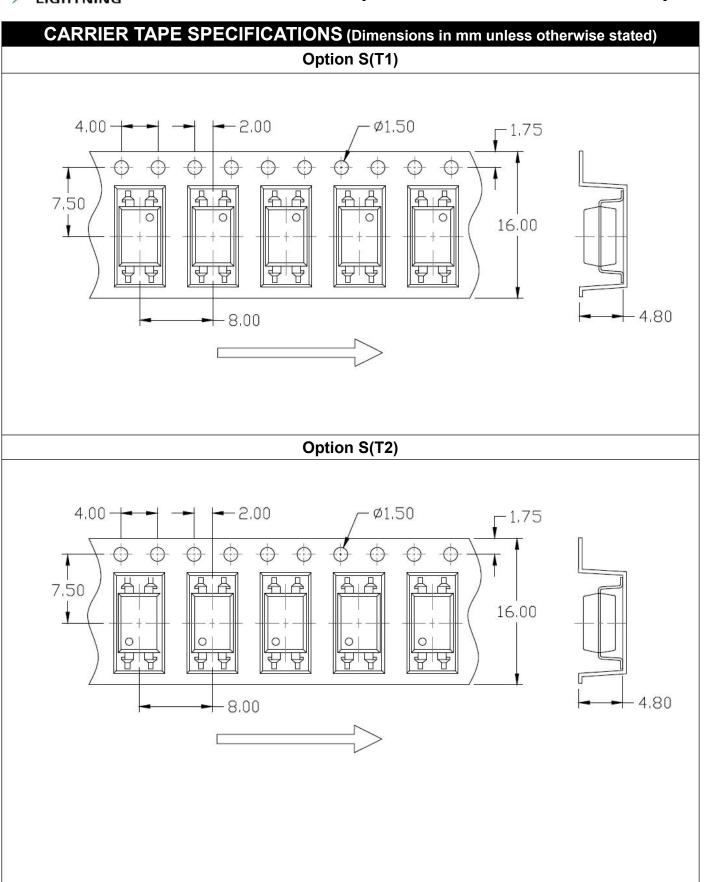




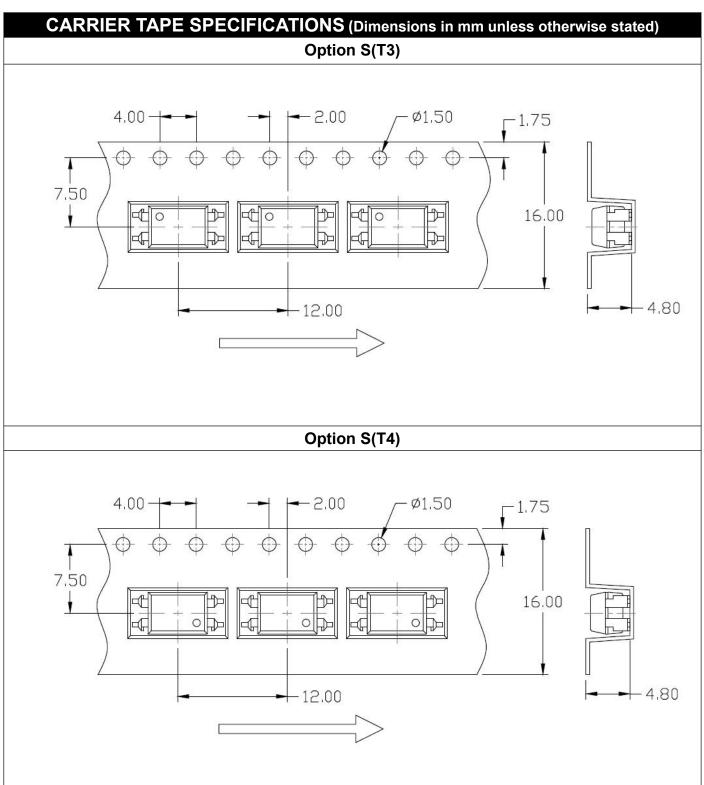
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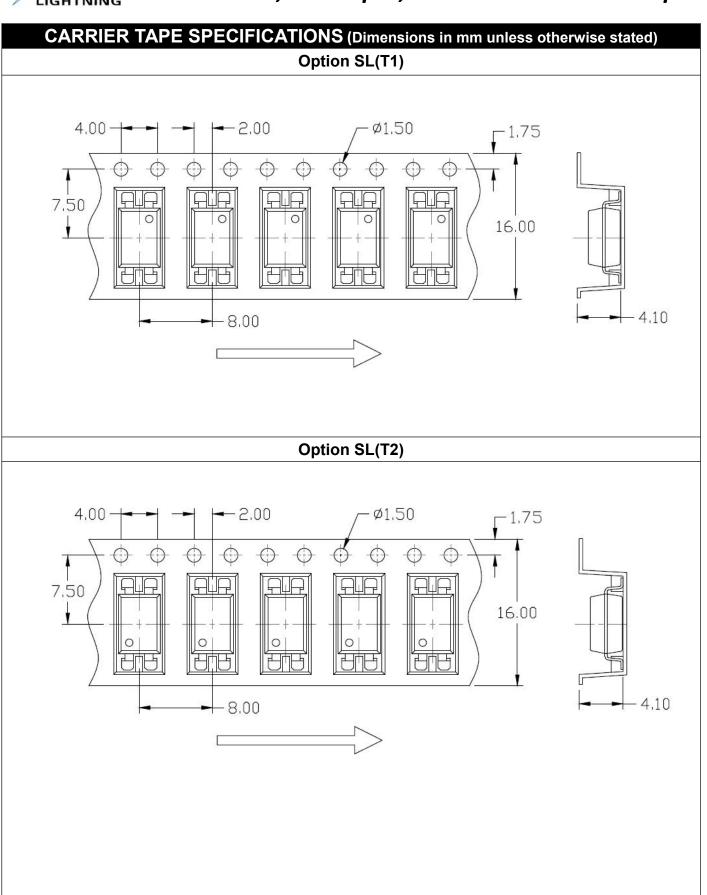




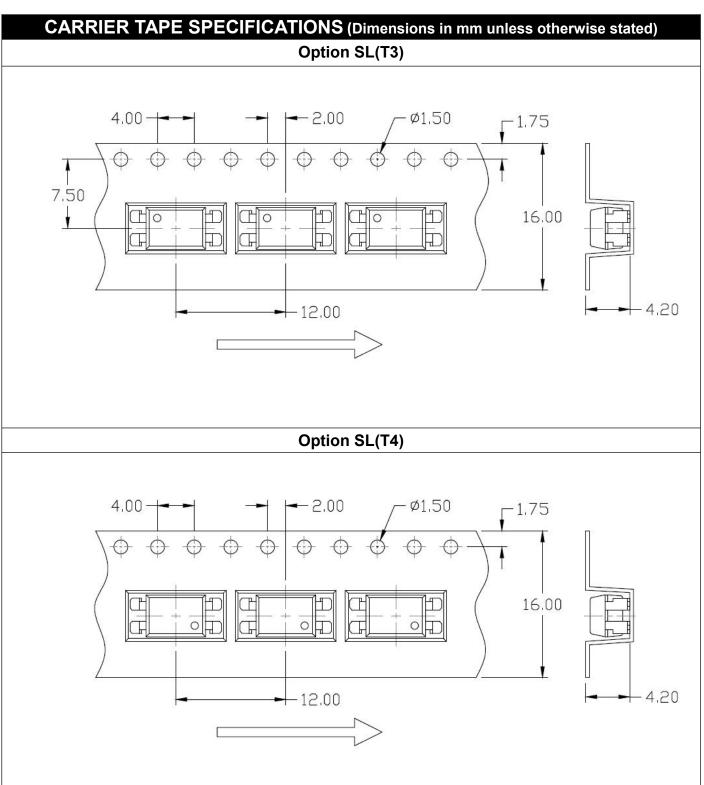




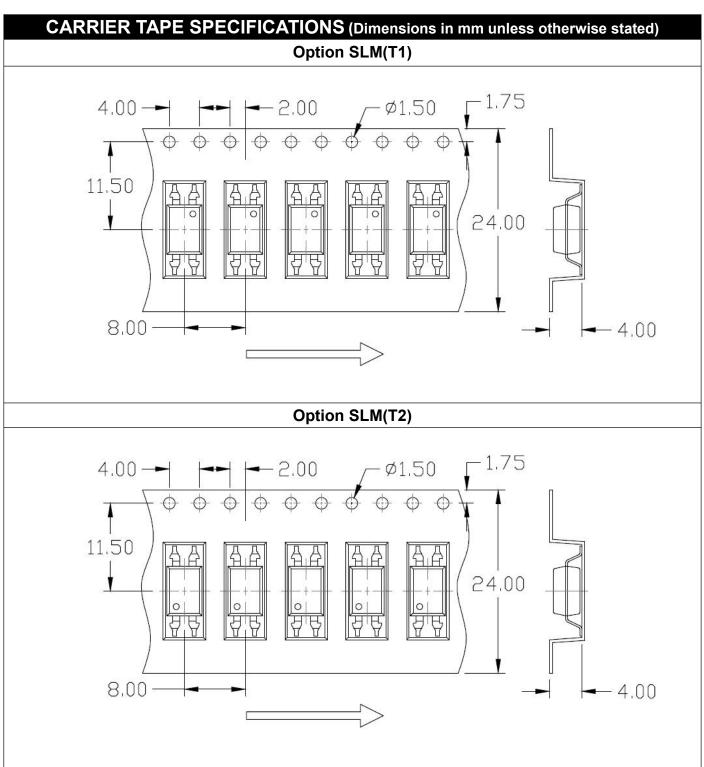




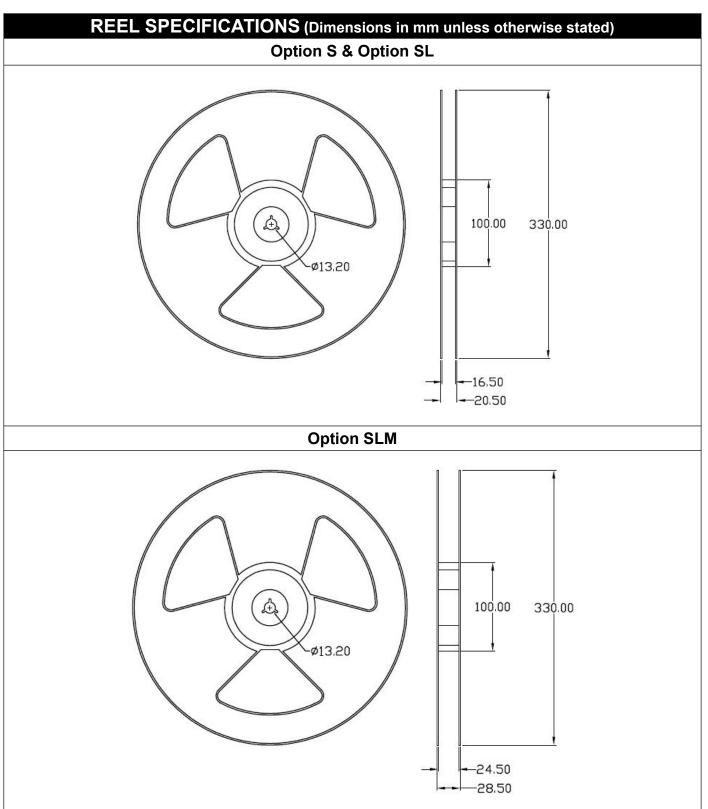




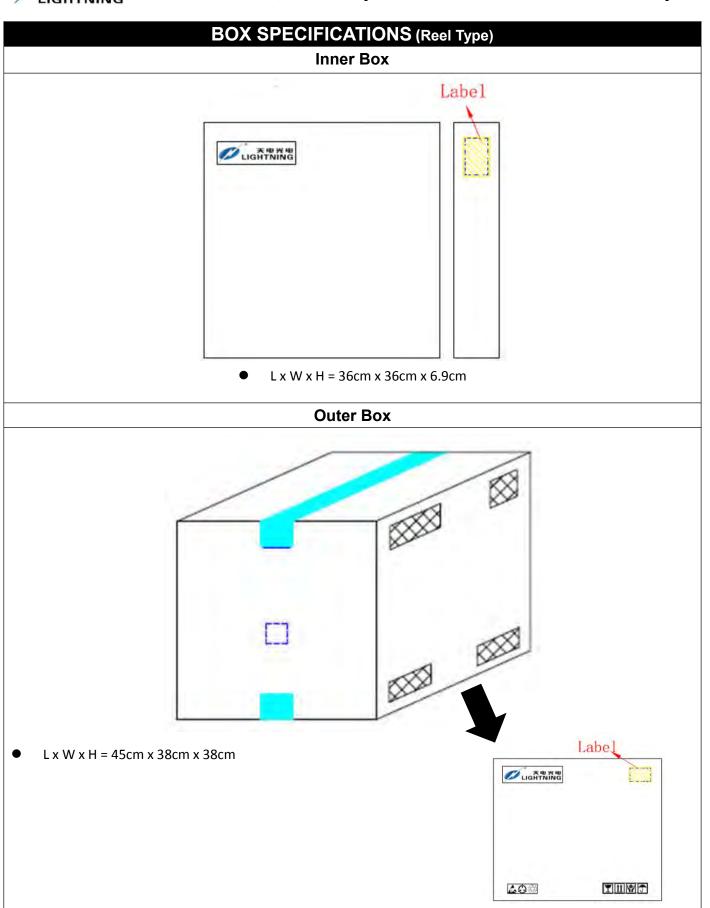














#### ORDERING AND MARKING INFORMATION

#### MARKING INFORMATION



TD: Company Abbr.

816 : Part Number

X : CTR Rank

V : VDE Option

Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

#### **ORDERING INFORMATION**

#### TD816X1(Y)(Z)-GV

TD - Company Abbr.

816 - Part Number

X1 - Rank (A1/B1/C1/D1/E1/F1/None)

Y – Lead Form Option (M/S/SL/SLM/None)

Z – Tape and Reel Option (T1/T2/T3/T4)

G – Green

V – VDE Option (V or None)

#### LABEL INFORMATION



#### **Packing Quantity**

Option	Quantity	Quantity – Inner box	Quantity – Outer box		
None	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
M	100 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 32k Units		
S(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
S(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
S(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T1)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T2)	1500 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 22.5k Units		
SL(T3)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T4)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SLM(T1)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SLM(T2)	1500 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box = 15k Units		

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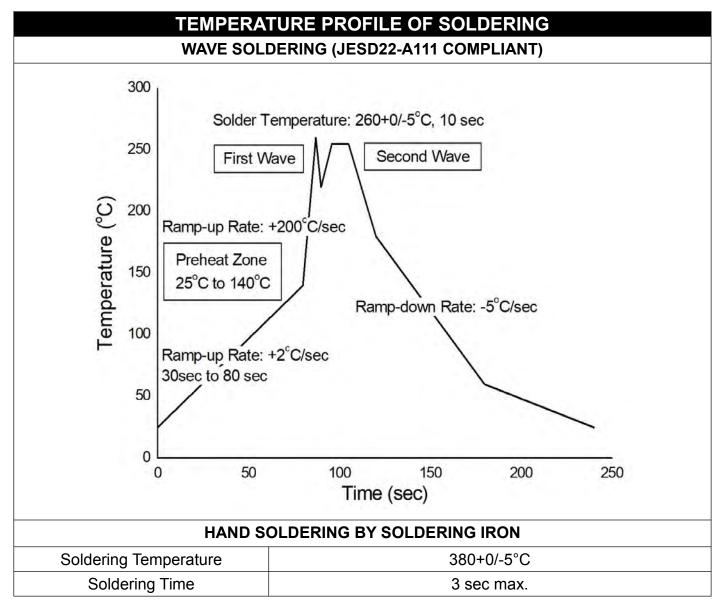


## DIP4, DC Input, Photo Transistor Coupler

## **REFLOW INFORMATION REFLOW PROFILE** Supplier T<sub>p</sub> ≥ T<sub>c</sub> User Tp ≤Tc T<sub>C</sub> -5°C Supplier tp Temperature 🕂 Tc -5°C Max. Ramp Up Rate = 3°C/s Max. Ramp Down Rate = 6°C/s TL T<sub>smax</sub> Preheat Area T<sub>smin</sub> 25 Time 25°C to Peak Time ⇒

Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



#### **DISCLAIMER**

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary
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- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.